

ABSTRACT OF THE DISCLOSUREDEVICE FOR PROTECTION AGAINST ELECTROSTATIC DISCHARGES
FOR MICROELECTRONIC COMPONENTS ON SOI TYPE SUBSTRATE

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5 The invention relates to a device (25) for
protection of an electronic component against
electrostatic discharges, the device (25) being made in
a semiconducting layer of a substrate, the
10 semiconducting layer covering an insulating layer, the
device being connected to a contact pin (21 to 24) to
protect the said component in order to divert an
electrostatic discharge, characterized in that the
device (25) comprises at least one Zener diode
10 connected to the said pin to be directly polarized.

Fig. 4